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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09 920,275	07 31 2001	Gregory M. Chrysler	042390.P12135	5708

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EXAMINER GEYER, SCOTT B

ART UNIT PAPER NUMBER

2829

DATE MAILED: 01.22.2003

Please find below and/or attached an Office communication concerning this application or proceeding.

		Application N	lo.	Applicant(s)	
·	09/920,275		CHRYSLER ET AL.	,	
Office Action	Examiner		Art Unit	· · · · · · · · · · · · · · · · · · ·	
	-	Scott B. Geye		2829	
The MAILING DAT	E of this communication ap				ss
Period for Reply				•	
THE MAILING DATE OF - Extensions of time may be availa after SIX (6) MONTHS from the n - If the period for reply specified ab - If NO period for reply is specified - Failure to reply within the set or e - Any reply received by the Office liearned patent term adjustment	TORY PERIOD FOR REPL THIS COMMUNICATION. ble under the provisions of 37 CFR 1. nailing date of this communication. rove is less than thirty (30) days, a rep above, the maximum statutory period xtended period for reply will, by statut ater than three months after the mailin see 37 CFR 1.704(b)	136(a). In no event, holy within the statutory will apply and will expect the application.	owever, may a reply be tim minimum of thirty (30) days ire SIX (6) MONTHS from n to become ABANDONE	rely filed s will be considered timely the mailing date of this commu	unication
Status					
	nmunication(s) filed on <u>26</u>		-		
2a) This action is FINA	, , ,	his action is nor			
3) Since this applicat closed in accordar	ion is in condition for allow nce with the practice under	ance except for Fx parte Quav	formal matters, pro le 1935 C.D. 11-4	osecution as to the m 53 O.G. 213	erits is
Disposition of Claims	μ.σ.σ.σ.σ.		o, 1000 o.b. 11, 1	00 0.0. 210.	
4) Claim(s) 1,2,4,5,7-	<u>17 and 25-27</u> is/are pendir	ng in the applica	tion.		
4a) Of the above cla	aim(s) is/are withdra	wn from consid	eration.		
5)	e allowed.				
6) Claim(s) <u>1,2,4,5,7,1</u>	<u>2-17 and 25-27</u> is/are reje	cted.			
7) Claim(s) is/a	re objected to.				
	subject to restriction and/o	or election requi	rement.		
Application Papers					
	objected to by the Examine				
10) The drawing(s) filed	on <u>12 July 2001</u> is/are: a)[accepted or b)	objected to by the	e Examiner.	
	equest that any objection to th				
11) The proposed drawir				ved by the Examiner.	
	ed drawings are required in re	• •	action.		
12) The oath or declarati		kaminer.			
Priority under 35 U.S.C. §§ 1					
	made of a claim for foreign	n priority under	35 U.S.C. § 119(a)	-(d) or (t).	
a) All b) Some *	, —				
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applicatio	certified copies of the prion from the International Buarled Office action for a list	ireau (PCT Rule	: 17.2(a)).	·	ļe
14) Acknowledgment is m	nade of a claim for domesti	ic priority under	35 U.S.C. § 119(e)) (to a provisional app	lication).
a) ☐ The translation ∈ 15)☐ Acknowledgment is n	of the foreign language pro nade of a claim for domest	• •			
Attachment(s)					
Notice of References Cited (P7 2) Notice of Draftsperson's Paten 3) Information Disclosure Stateme		4) _ 5) _ 6) _	_	(PTO-413) Paper No(s) atent Application (PTO-152	

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DETAILED ACTION

Specification

1. The specification as amended by the applicant is acceptable.

Claim Objections

2. Claims 13 and 17 as amended by the applicant are acceptable. Claims 3 and 20 have been canceled by the applicant.

Claim Rejections - 35 USC § 112

3. The following is a quotation of the second paragraph of 35 U.S.C. 112:

The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.

4. Claim 15 is rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention. Claim 15 recites a layer of polysilicon on the layer of monocrystalline silicon, the layer of monocrystalline silicon being located on the layer of polysilicon". It is unclear from the claim language as to whether the layer of polysilicon is on top of the layer of monocrystalline or beneath the layer of monocrystalline silicon. This claim has not been treated further on its merits.

Claim Rejections - 35 USC § 102

5. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless –

⁽b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

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6. Claims 1, 2, 4 and 5 are rejected under 35 U.S.C. 102(b) as being anticipated by Tanabe et al. (6,051,063).

As to *claim 1*, Tanabe et al. teach a wafer consisting of a layer of diamond on a monocrystalline silicon semiconductor material (column 4, lines 34-49). Further, Tanabe et al. teach silicon wafers with a plurality of electronic devices (integrated circuits) (column 2, lines 7-22).

As to *claim 2*, Tanabe et al. teach a layer of solid diamond film with a diameter of up to 8 inches (203.2 mm) (see table 1, column 9).

As to *claim 4*, Tanabe et al. teach a single silicon crystal substrate with a diameter of up to 8 inches (203.2 mm) (see table 1, column 9).

As to *claim 5*, Tanabe et al. teach the layer of monocrystalline semiconductor material as a layer of monocrystalline silicon (Si single crystal wafer) (column 4, line 42).

- (a) the invention was known or used by others in this country, or patented or described in a printed publication in this or a foreign country, before the invention thereof by the applicant for a patent.
- **7.** Claim 12 is rejected under 35 U.S.C. 102(a) as being anticipated by Clevenger et al. (6,337,513 B1).

As to *claim 12*, Clevenger et al. teach a layer of solid diamond having an exposed lower surface and an integrated circuit (chip) on the layer of solid diamond as is shown in figure 3.

As to *claim 13*, Clevenger et al. teach a layer of solid diamond having an exposed lower surface and an integrated circuit (chip) on the layer of solid diamond as

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is shown in figure 3. Clevenger et al. also teach diamond formed on single crystal silicon (column 3, lines 50 et seq.).

As to *claim 14*, Clevenger et al. teach a layer of solid diamond having an exposed lower surface and an integrated circuit (chip) on the layer of solid diamond as is shown in figure 3. Clevenger et al. also teach diamond formed on <u>single crystal</u> silicon (emphasis added) (column 3, lines 50 et seq.).

As to *claim 16*, Clevenger et al. teach a plurality of contacts (see solder balls in figure 3).

Claim Rejections - 35 USC § 103

- **8.** The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- **9.** Claim 7 is rejected under 35 U.S.C. 103(a) as being unpatentable over Tanabe et al. (6,051,063) as applied to claim 1 above, and further in view of Nagy (5,696,665).

As to *claim* 7, Tanabe et al. does not specifically teach an integrated circuit having a plurality of contacts. However, Nagy teaches an integrated circuit with a plurality of contacts wherein the integrated circuit is located on a diamond substrate (see figure 2). At the time of the invention, it would have been obvious to a person of ordinary skill to modify the integrated circuit disclosed by Tanabe et al with a plurality of

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contacts as taught by Nagy so as to provide a means for functionality of the semiconductor device.

10. Claim 17 is rejected under 35 U.S.C. 103(a) as being unpatentable over Clevenger et al. (6,337,513 B1) as applied to claim 12 above, and further in view of Nagy (5,696,665).

As to *claim 17*, Clevenger et al. do not specifically teach a die with a rectangular outline. However, Nagy teaches a die 11 as see in figure 2, with a rectangular outline. At the time of the invention, it would have been obvious to a person of ordinary skill to modify the chip (die) of Clevenger et al. with a rectangular shape as taught by Nagy as the rectangular shape is extremely notorious in the art of semiconductor devices and is further readily produced by dicing wafers with a saw which can easily produce rectangular, or square, shaped singulated dies.

11. Claims 25-27 are rejected under 35 U.S.C. 103(a) as being unpatentable over Tanabe et al. (6,051,063).

As to *claim 25*, Tanabe et al. teach a wafer consisting of a layer of diamond on a monocrystalline silicon semiconductor material (column 4, lines 34-49). Further, Tanabe et al. teach silicon wafers with a plurality of electronic devices (integrated circuits) (column 2, lines 7-22). Tanabe et al. also teach the diamond film having a thickness less than 150 microns (see table 1, column 9). Tanabe et al. does not explicitly teach a plurality of electronic devices in "rows and columns". However, it

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would have been obvious to a person of ordinary skill in the art that a 'plurality' defines two (or more) objects, and at least two objects would then necessarily define either a single row and two columns or two rows and one column, depending upon the vantage point of the two objects.

Allowable Subject Matter

- **12.** Claims 8-11 are allowed.
- 13. The following is a statement of reasons for the indication of allowable subject matter: the prior art of record and to the examiner's knowledge does not teach or render obvious, at least to the skilled artisan, the instant invention regarding a wafer wherein a final monocrystalline semiconductor film is layered on a layer of solid diamond and a layer of monocrystalline semiconductor material is layered directly on the final monocrystalline semiconductor film with a boundary defined between the final monocrystalline semiconductor film and the layer of monocrystalline semiconductor material for purposes of shearing the layer of monocrystalline semiconductor material from the final monocrystalline semiconductor film. Claims 9-11 are dependent from claim 8.
- **14.** Claim 26 is objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims. The prior art of record and to the examiner's knowledge does not teach or render obvious, at least to the skilled artisan, the instant invention regarding a layer of monocrystalline semiconductor material *between* the layer of diamond and the integrated circuit. Claim 27 is dependent upon claim 26.

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Response to Arguments

15. Applicant's arguments with respect to claims 1, 2, 4, 5, 7, 12-17 and 25-27 have been considered but are moot in view of the new ground(s) of rejection.

Conclusion

16. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Scott B. Geyer whose telephone number is (703) 306-5866. The examiner can normally be reached on weekdays, between 10:00am - 6:30pm. The examiner may also be reached via e-mail: scott.geyer@uspto.gov

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Kamand Cuneo can be reached on (703) 308-1233. The fax phone numbers for the organization where this application or proceeding is assigned are (703) 872-9318 for regular communications and (703) 872-9319 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703) 308-0956.

556.

S.B.G. January 14, 2003 KAMAND CUNEO

SUPERVISORY PATENT EXAMINER
TECHNOLOGY CENTER 2800